

SEMITRANS[®] 3

SPT IGBT Module

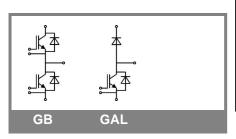
SKM 300GB128D SKM 300GAL128D

Features

- Homogeneous Si
- SPT = Soft-Punch-Through technology
- V_{CEsat} with positive temperature coefficient
- · High short circuit capability, self limiting to 6 x I_c

Typical Applications

- AC inverter drives
- **UPS**
- Electronic welders at f_{sw} up to 20



Absolute	Absolute Maximum Ratings T _c = 25 °C, unless otherwise specified				
Symbol	Conditions		Values	Units	
IGBT					
V_{CES}	T _j = 25 °C T _i = 150 °C		1200	V	
I _C	T _j = 150 °C	T _c = 25 °C	370	Α	
		T _c = 80 °C	265	А	
I _{CRM}	I _{CRM} =2xI _{Cnom}		400	Α	
V _{GES}			± 20	V	
t _{psc}	V_{CC} = 600 V; $V_{GE} \le 20$ V; $V_{CES} < 1200$ V	T _j = 125 °C	10	μs	
Inverse [Diode				
I_{F}	T _j = 150 °C	T_{case} = 25 °C	260	Α	
		T _{case} = 80 °C	180	Α	
I_{FRM}	I _{FRM} =2xI _{Fnom}		400	Α	
I _{FSM}	t_p = 10 ms; sin.	T _j = 150 °C	1800	Α	
Freewhe	eling Diode				
I_{F}	T _j = 150 °C	T_{case} = 25 °C	260	Α	
		T _{case} = 80 °C	180	Α	
I _{FRM}	I _{FRM} =2xI _{Fnom}		400	Α	
I _{FSM}	$t_p = 10 \text{ ms; sin.}$	T _j = 150 °C	1800	А	
Module					
$I_{t(RMS)}$			500	Α	
T _{vj}			- 40+ 150	°C	
T _{stg}			- 40+ 125	°C	
V _{isol}	AC, 1 min.		4000	V	

Characteristics $T_c =$		25 °C, unless otherwise specified				
Symbol	Conditions		min.	typ.	max.	Units
IGBT						
$V_{\text{GE(th)}}$	$V_{GE} = V_{CE}$, $I_{C} = 8 \text{ mA}$		4,5	5,5	6,5	V
I _{CES}	$V_{GE} = 0 V, V_{CE} = V_{CES}$	T _j = 25 °C		0,2	0,6	mA
V_{CE0}		T _j = 25 °C		1	1,15	V
		T _j = 125 °C		0,9	1,05	V
r _{CE}	V _{GE} = 15 V	T _j = 25°C		4,5	6	mΩ
		T _j = 125°C		6	7,5	$m\Omega$
V _{CE(sat)}	I _{Cnom} = 200 A, V _{GE} = 15 V			1,9	2,35	V
		$T_j = 125^{\circ}C_{chiplev}$		2,1	2,55	V
C _{ies}				17		nF
C _{oes}	$V_{CE} = 25, V_{GE} = 0 V$	f = 1 MHz		2		nF
C _{res}				1,9		nF
Q_G	V _{GE} = -8V - +20V			2400		nC
R _{Gint}	T _j = 25 °C			2		Ω
t _{d(on)}				170		ns
t _r	$R_{Gon} = 5 \Omega$	V _{CC} = 600V		55		ns
E _{on}	D 50	I _{Cnom} = 200A		22		mJ
t _{d(off)}	$R_{Goff} = 5 \Omega$	T _j = 125 °C		660		ns
t _f		V _{GE} = ±15V		60		ns
E _{off}		L _s = 20 nH		22		mJ
R _{th(j-c)}	per IGBT				0,085	K/W



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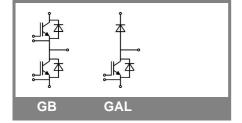
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Character	ristics					
Symbol	Conditions		min.	typ.	max.	Units
Inverse D						
$V_F = V_{EC}$	I_{Fnom} = 200 A; V_{GE} = 0 V	$T_j = 25 ^{\circ}C_{\text{chiplev.}}$		2	2,5	V
		$T_j = 125 ^{\circ}C_{chiplev.}$		1,8		V
V_{F0}		T _j = 25 °C		1,1	1,2	V
r _F		T _j = 25 °C		4,5	6,5	mΩ
I _{RRM}	I _{Fnom} = 200 A	T _i = 125 °C		280		Α
Q_{rr}	di/dt = 6300 A/μs	$L_S = 20 \text{ nH}$		33		μC
E _{rr}	V _{GE} = -15 V; V _{CC} = 600 V			11		mJ
R _{th(j-c)D}	per diode				0,18	K/W
FWD						•
$V_F = V_{EC}$	I_{Fnom} = 200 A; V_{GE} = 0 V	T _j = 25 °C _{chiplev.}		2	2,5	V
		$T_j = 125 ^{\circ}C_{chiplev.}$		1,8		V
V_{F0}		T _j = 25 °C		1,1	1,2	V
r _F		T _j = 25 °C		4,5	6,5	V
I _{RRM}	I _{Fnom} = 200 A	T _j = 25 °C		280		Α
Q_{rr}	di/dt = 6300 A/μs	L _S = 20 nH		33		μC
E _{rr}	$V_{GE} = -15 \text{ V}; V_{CC} = 600 \text{ V}$			11		mJ
$R_{th(j-c)FD}$	per diode				0,18	K/W
Module						
L _{CE}				15	20	nΗ
R _{CC'+EE'}	res., terminal-chip	T _{case} = 25 °C		0,35		mΩ
		T _{case} = 125 °C		0,5		mΩ
R _{th(c-s)}	per module				0,038	K/W
M _s	to heat sink M6		3		5	Nm
M _t	to terminals M6		2,5		5	Nm
w					325	g

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.





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